



**The Abdus Salam
International Centre for Theoretical Physics**



2177-3

**ICTP Latin-American Basic Course on FPGA Design for Scientific
Instrumentation**

15 - 31 March 2010

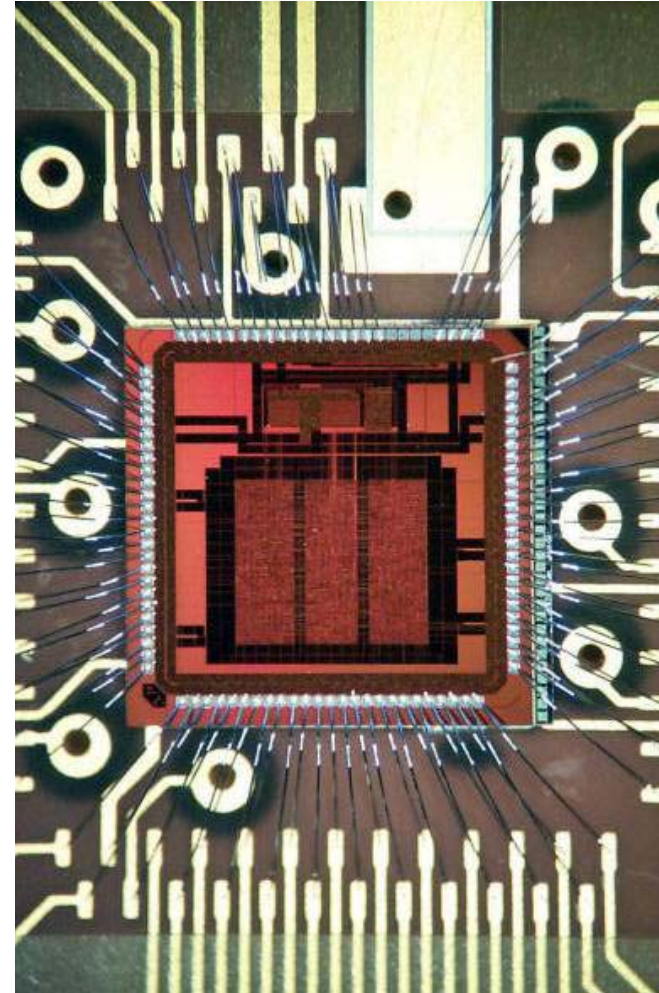
The CMOS inverter

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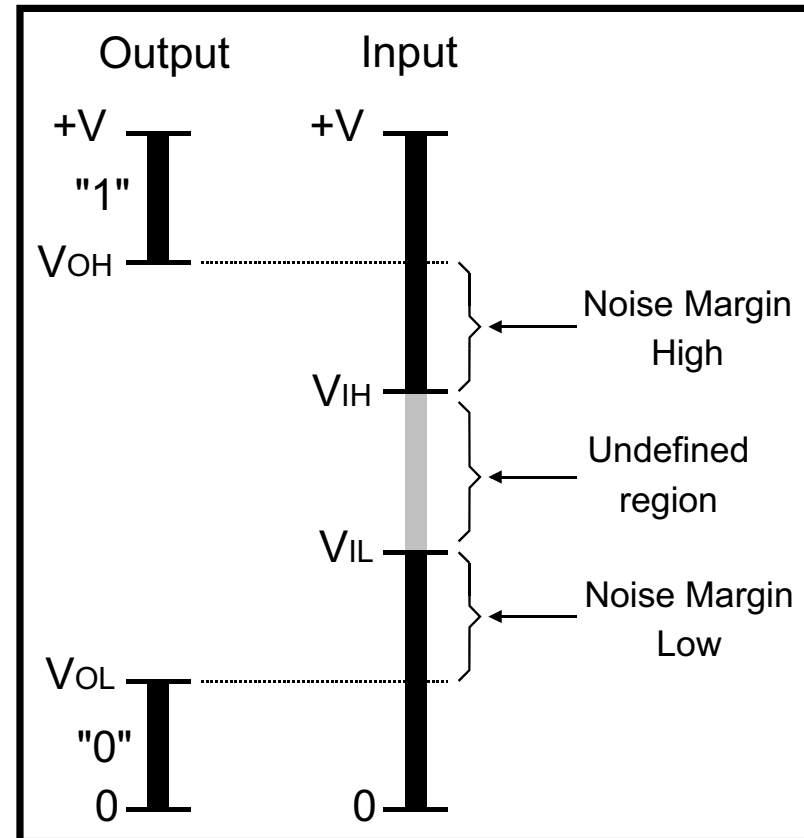
Outline

- Introduction
- Transistors
- **The CMOS inverter**
 - DC operation
 - Dynamic operation
 - Propagation delay
 - Power consumption
 - Layout
- Technology
- Scaling
- Gates
- Sequential circuits
- Storage elements
- Phase-Locked Loops
- Example



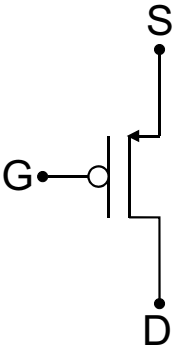
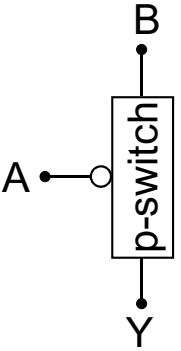
CMOS logic: "0" and "1"

- Logic circuits process Boolean variables
- Logic values are associated with voltage levels:
 - $V_{IN} > V_{IH} \Rightarrow "1"$
 - $V_{IN} < V_{IL} \Rightarrow "0"$
- Noise margin:
 - $NM_H = V_{OH} - V_{IH}$
 - $NM_L = V_{IL} - V_{OL}$



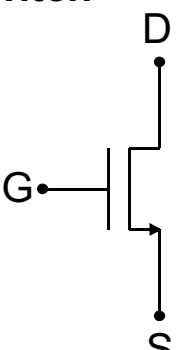
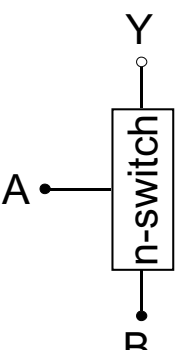
The MOST - a simple switch

p-switch

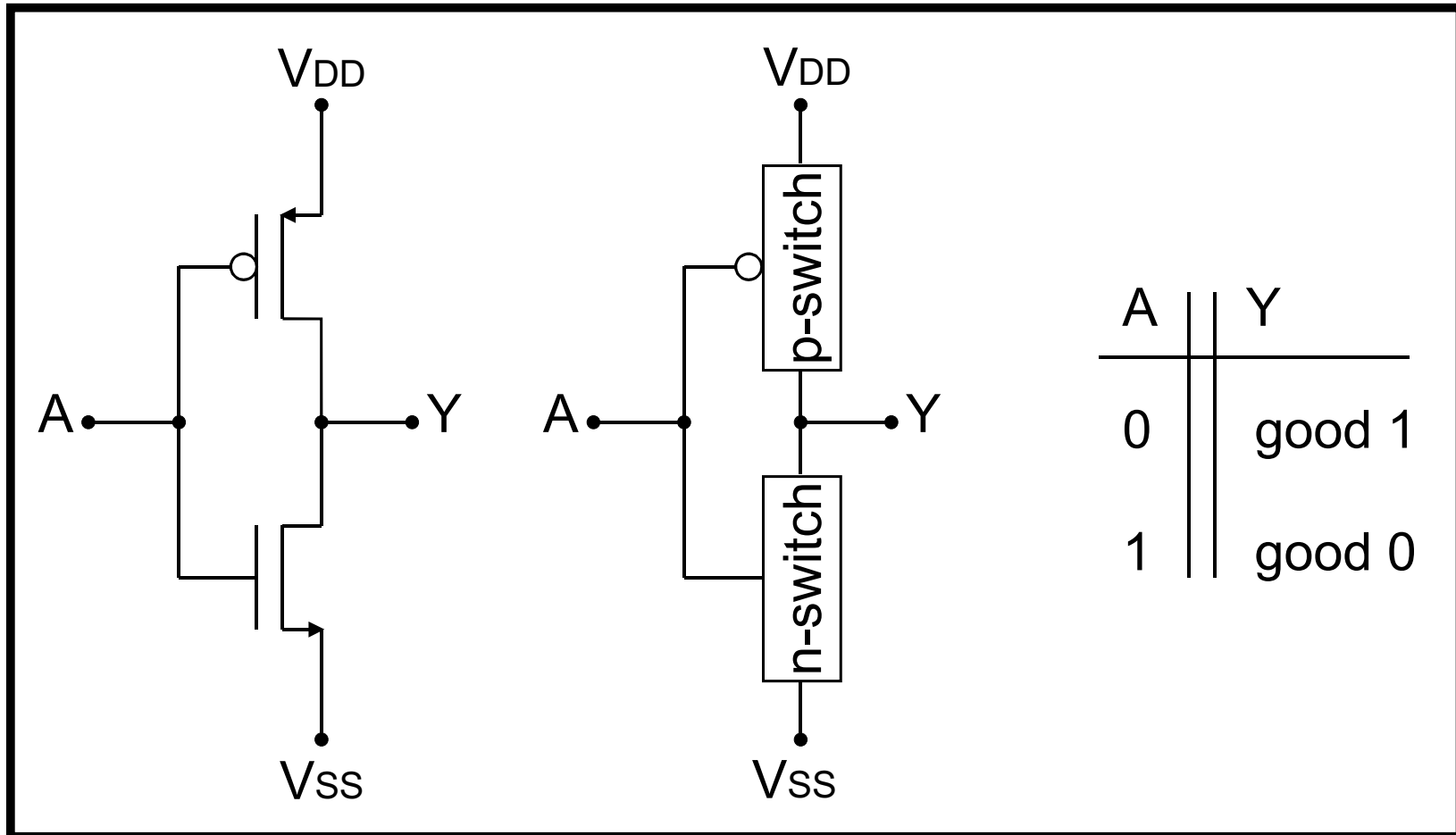
A	B	Y
0	0	bad 0 (source follower)
0	1	good 1
1	0	? (high Z)
1	1	? (high Z)

n-switch

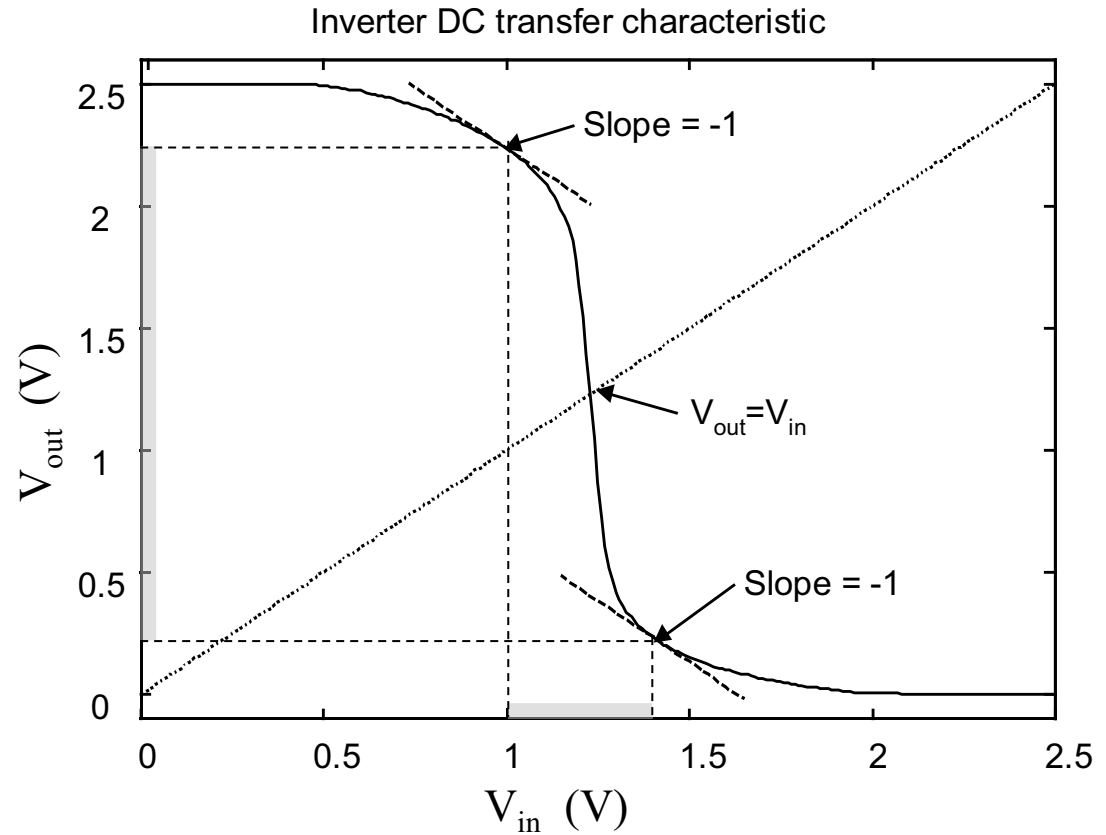
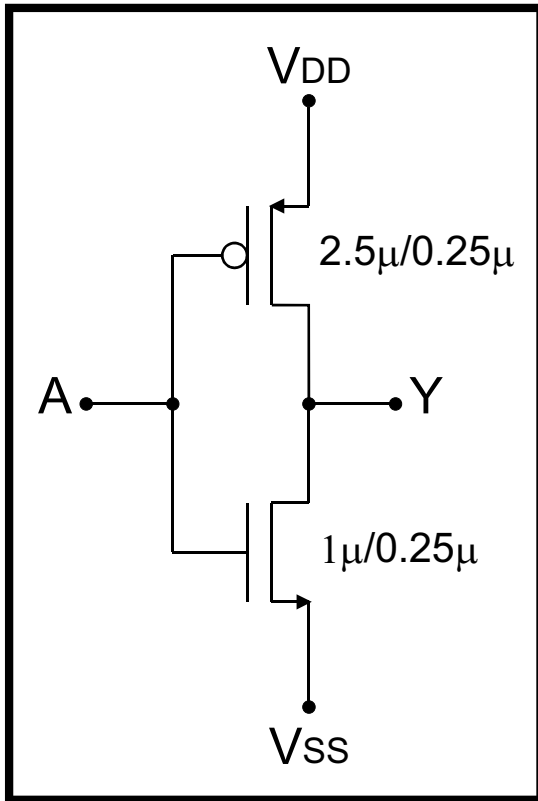



A	B	Y
0	0	? (high Z)
0	1	? (high Z)
1	0	good 0
1	1	bad 1 (source follower)

The CMOS inverter



DC operation

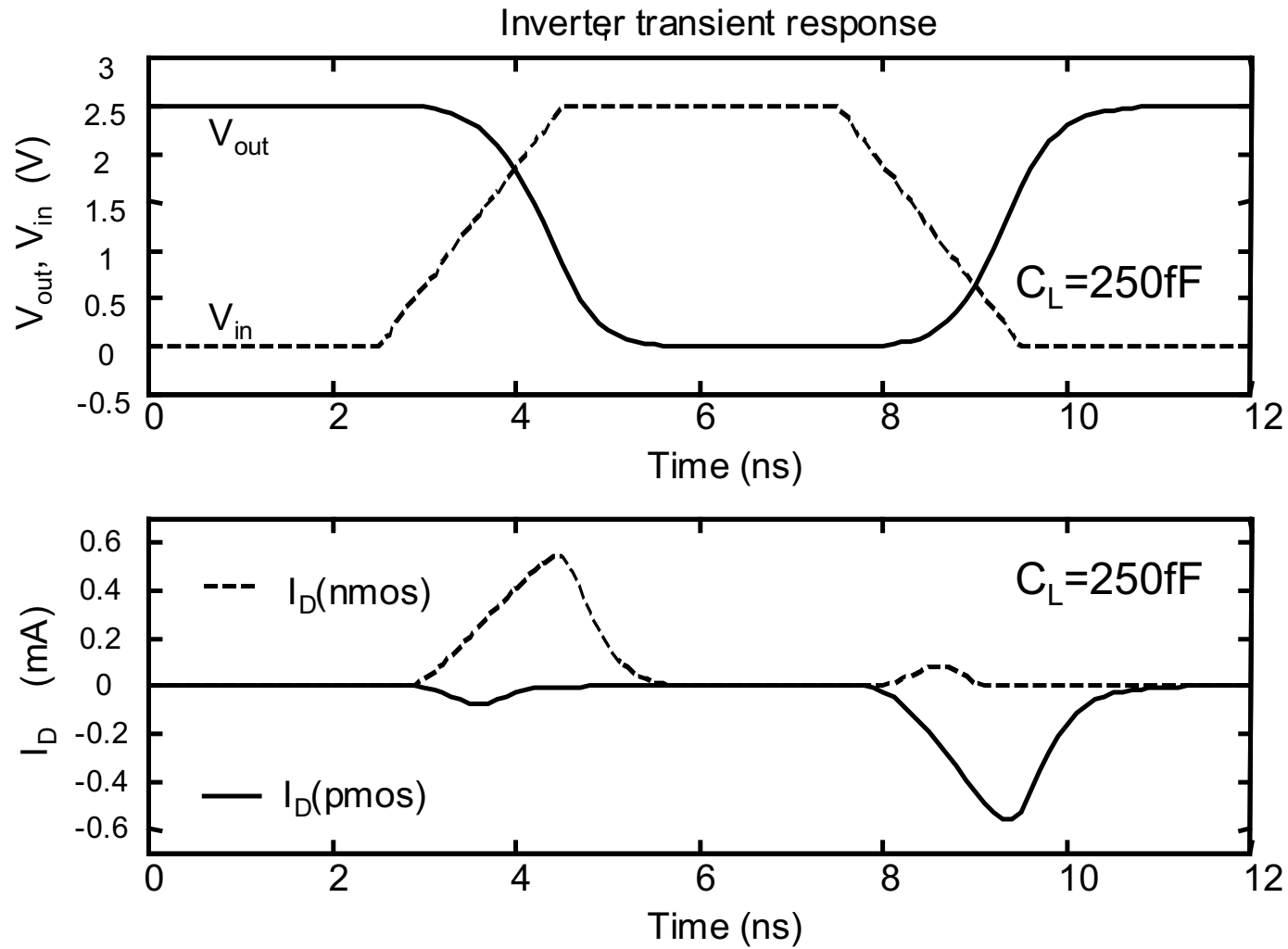


DC operation

Regions of operation (balanced inverter):

V_{in}	n-MOS	p-MOS	V_{out}
0	cut-off	linear	V_{dd}
$V_{TN} < V_{in} < V_{dd}/2$	saturation	linear	$\sim V_{dd}$
$V_{dd}/2$	saturation	saturation	$V_{dd}/2$
$V_{dd} - V_{TP} > V_{in} > V_{dd}/2$	linear	saturation	~ 0
V_{dd}	linear	cut-off	0

Dynamic operation



Dynamic operation

- Propagation delay
 - Main origin: load capacitance

$$t_{pLH} = \frac{C_L \cdot L_p \cdot V_{dd}}{\mu_p \cdot C_{ox} \cdot W_p \cdot (V_{dd} - |V_{TP}|)^2} \approx \frac{C_L}{k_p \cdot V_{dd}}$$

$$t_{pHL} = \frac{C_L \cdot L_n \cdot V_{dd}}{\mu_n \cdot C_{ox} \cdot W_n \cdot (V_{dd} - |V_{TN}|)^2} \approx \frac{C_L}{k_n \cdot V_{dd}}$$

$$t_p \approx \frac{1}{2} (t_{pLH} + t_{pHL}) = \frac{C_L}{2 \cdot V_{dd}} \left(\frac{1}{k_n} + \frac{1}{k_p} \right)$$

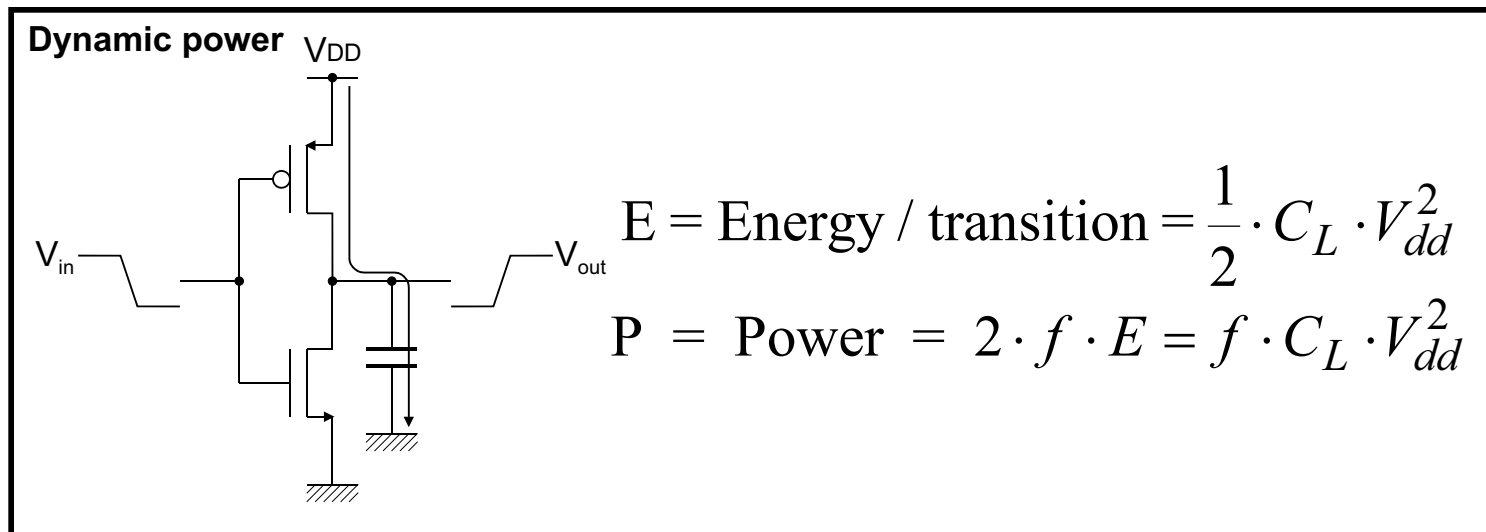
- To reduce the delay:
 - Reduce C_L
 - Increase k_n and k_p . That is, increase W/L

Dynamic operation

- CMOS power budget:
 - Dynamic power consumption:
 - Charging and discharging of capacitors
 - Short circuit currents:
 - Short circuit path between power rails during switching
 - Leakage
 - Leaking diodes and transistors

Dynamic operation

- The dynamic power dissipation is a function of:
 - Frequency
 - Capacitive loading
 - Voltage swing
- To reduce dynamic power dissipation
 - Reduce: C_L
 - Reduce: f
 - Reduce: $V_{dd} \Leftarrow$ The most effective action



Layout

